

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image























High-temperature-resistant, straight, open pin header. Packed in box or tape. On tape and with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

General ordering data

Version	PCB plug-in connector, male header, Solder flange, THT/THR solder connection, 5.08 mm, Number of poles: 8, 270°, Solder pin length (I): 1.5 mm, tinned, black, Tape
Order No.	<u>1876980000</u>
Туре	SL-SMT 5.08HC/08/270FH 1.5SN BK RL
GTIN (EAN)	4032248467631
Qty.	195 pc(s).
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A
Packaging	Tape

Creation date September 16, 2022 8:23:15 PM CEST



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Technical data

Dimensions and weights

Depth	12 mm	Depth (inches)	0.472 inch
Height	12.5 mm	Height (inches)	0.492 inch
Height of lowest version	11 mm	Width	50.44 mm
Width (inches)	1.986 inch	Net weight	5.14 g

System specifications

Product family	OMNIMATE Signal - series	Type of connection	
•	BL/SL 5.08		Board connection
Mounting onto the PCB	THT/THR solder	Pitch in mm (P)	
	connection		5.08 mm
Pitch in inches (P)	0.2 inch	Outgoing elbow	270°
Number of poles	8	Number of solder pins per pole	1
Solder pin length (I)	1.5 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder eyelet hole diameter (D)	1.4 mm
Solder eyelet hole diameter tolera	ance (D)+ 0,1 mm	L1 in mm	35.56 mm
L1 in inches	1.4 inch	Number of rows	1
Pin series quantity	1	Protection degree	IP20
Volume resistance	≤5 mΩ	Can be coded	Yes
Plugging force/pole, max.	9 N	Pulling force/pole, max.	7 N

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuMg
Contact surface		Layer structure of solder connection	13 µm Ni / 24 µm Sn
	tinned		matt
Layer structure of plug contact	13 μm Ni / 24 μm Sn	Storage temperature, min.	
	matt	- '	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	27.5 A
Rated current, max. number of poles		Rated current, min. number of poles	
(Tu=20°C)	19 A	(Tu=40°C)	24 A
Rated current, max. number of poles (Tu=40°C)	16.5 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV		



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Rated data acc. to CSA

Institute (CSA)		Certificate No. (CSA)	
	(SP∙		
	•		200039-1176845
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	18.5 A	Rated current (Use group D / CSA)	18.5 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		
Packing			
Packaging	Tape	VPE length	330 mm
/PE width	330 mm	VPE height	77 mm
Tape depth (T2)	15.5 mm	Tape width (W)	72 mm
Tape pocket depth (KO)	15 mm	Tape pocket height (A0)	12.3 mm
Tape pocket width (B0)	20.4 mm	Tape pocket separation (P1)	16 mm
Tape hole separation (E)	1.75 mm	Tape pocket separation (F)	20.2 mm
Гаре reel diameter ∅ (A)	330 mm	Surface resistance	Rs = $10^9 - 10^{12} \Omega$
Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01
Important note			
PC conformity	Conformity: The products are de	eveloped, manufactured and delivered according	ng international recognized
. 0 00	standards and norms and comp	ly with the assured properties in the data shee Class 2". Further claims on the products can be	et resp. fulfill decorative properti
Votes	Gold-plated contact surfaces	on request	
	 Rated current related to rated 	cross-section & min. No. of poles.	
	 Rated current related to rated Diameter of solder eyelet D = 	·	
		· · 1.4+0.1mm	
	Diameter of solder eyelet D =	· · 1.4+0.1mm	
	 Diameter of solder eyelet D = Solder eyelet diameter D = 1. P on drawing = pitch Rated data refer only to the contraction. 	· · 1.4+0.1mm	nces to other components are



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Approvals

Approvals	(1)	

ROHS	Conform
UL File Number Search	UL Website
Certificate No. (UR)	E60693

Downloads

Approval/Certificate/Document of	
Conformity	Declaration of the Manufacturer
Engineering Data	CAD data – STEP
Catalogues	Catalogues in PDF-format
Brochures	<u>FL DRIVES EN</u>
	MB SMT EN
	FL DRIVES DE
	MB DEVICE MANUF. EN
	FL BUILDING SAFETY EN
	FL APPL LED LIGHTING EN
	FL INDUSTR.CONTROLS EN
	FL MACHINE SAFETY EN
	FL HEATING ELECTR EN
	FL APPL_INVERTER EN
	FL_BASE_STATION_EN
	FL ELEVATOR EN
	FL POWER SUPPLY EN
	FL 72H SAMPLE SER EN
	PO OMNIMATE EN
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White paper surface mount technology	Download Whitepaper



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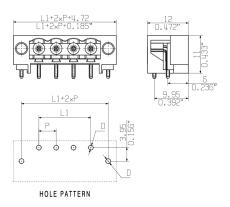
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Drawings

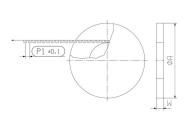
Product image



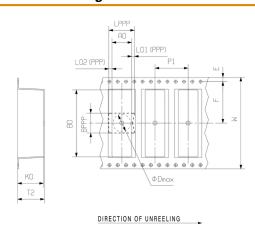
Dimensional drawing



Dimensional drawing



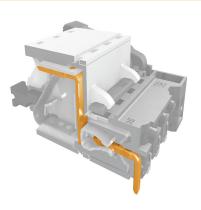
Dimensional drawing



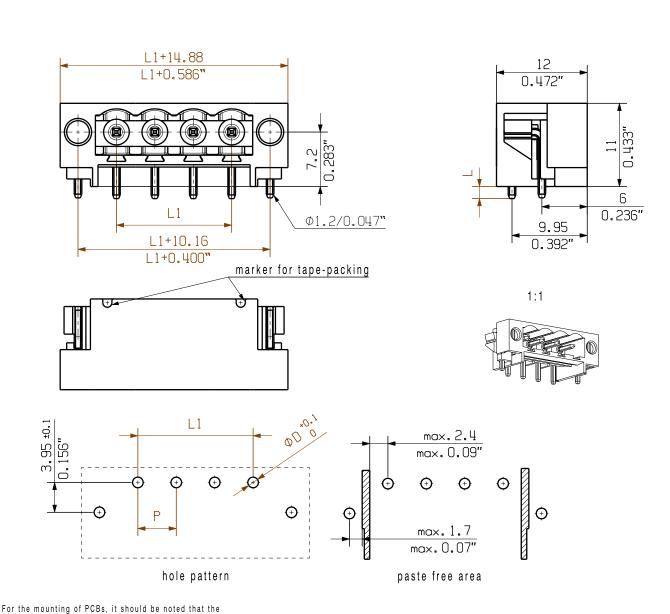
Example of use



Product benefits



Safe power transmission Proven properties



rated data given in the catalogue relates only to the connection elements. The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to VDE 0110. The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller connectors are tested to the DIN VDE 0627 standard, and are valid for its field of application. Provided that the connectors are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.

D = 1.4/0.055" (reflow soldering) recommendation for automatic assembly $(1.4 \,\mathrm{mm} \,\,\text{for}\,\, n = 2...8)$

P = Pitch

DIN ISO 2768-m

shown: SL-SMT 5.08HC/04/270FH

1,5	0
1,5	-0.3
3.2	0.1
3,2	-0.3
pin lenght L	tolerance

n	L1 [mm]	L1 [Inch]	tolerance L1
2	5,08	0,200	
3	10,16	0,400	
4	15,24	0,600	
5	20,32	0,800	±0.1
6	25,40	1,000	
7	30,48	1,200	
8	35,56	1,400	

GENERAL TOLERANCE:

91033/4 03.02.17 HERTEL_S ROHS Modification Date Name 23.03.2004 DOMRATH_M Drawn HERTEL S Responsible Scale: 2/1 HELIS_MA 06.02.2017 Checked Supersedes: . LANG_T Approved

Weidmüller 🐔

Cat.no.:. 37899 Drawing no.

17 Issue no Sheet 04 sheets

SL-SMT 5.08HC/../270... STIFTLEISTE

MALE HEADER

Product file: SL-SMT 5.08 7313



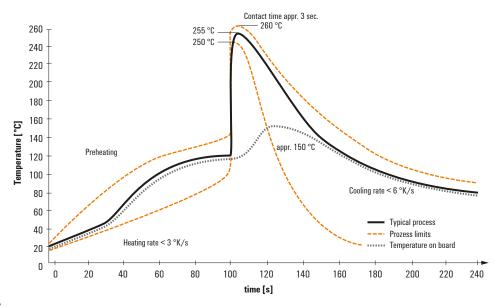
Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG

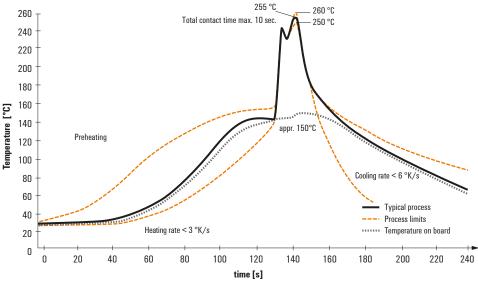
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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

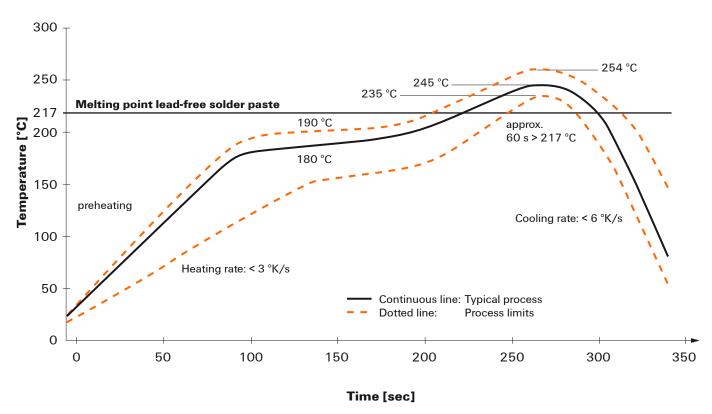


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.